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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

2823  
Atty. Docket No.: BU9-99-197

Response Transmittal

In re application of Endakawa, et al.

Serial No.: 09/599,783

Filed: 06/22/2000

For: METHOD FOR ETCHING A SEMICONDUCTOR SUBSTRATE  
USING GERMANIUM HARD MASK

Box No Fee

Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Sir:

Transmitted herewith for filing in the above-identified Application is a:

1. Response; and
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| on <u>June 11, 2002</u><br><br>Heather Clark  |

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☒ Any additional filing fees required under 37 C.F.R. §1.16.

☒ Any patent application processing fees under 37 C.F.R. §1.17.

Date: June 11, 2002

Respectfully submitted,

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By   
Keith L. Jenkins  
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AMENDMENT

Docket No. BU9-99-197

Applicant: Furukawa, et al. Docket No.: BU9-99-197  
Serial No.: 09/599,783 Group Art Unit: 2823  
Filed: 06/22/2000 Examiner: Maldonado, Julio J.  
TITLE: METHOD FOR ETCHING A  
SEMICONDUCTOR  
SUBSTRATE USING  
GERMANIUM HARD  
MASK

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The Commissioner of Patents and Trademarks  
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Sir:

In response to the office action dated March 13, 2002, please amend the subject  
application as follows:

I HEREBY CERTIFY THAT THE CORRESPONDENCE TO WHICH THIS STATEMENT IS AFFIXED IS BEING DEPOSITED WITH  
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